

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HISANORI MATSUO	01/08/2016
KEISUKE SUZUKI	01/08/2016
TAKAHIRO TAJIRI	01/08/2016
PANART KHAJORNRUNGRUANG	01/08/2016
YOSHIHIRO MOCHIZUKI	01/08/2016
RECEIVING PARTY DATA	
Name:	EBARA CORPORATION
Street Address:	11-1, HANEDA ASAHI-CHO, OHTA-KU
City:	TOKYO
State/Country:	JAPAN
Name:	KYUSHU INSTITUTE OF TECHNOLOGY
Street Address:	1-1 SENSUI-CHO, TOBATA-KU, KITAKYUSHU-SHI
City:	FUKUOKA
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14974898
CORRESPONDENCE DATA	
Fax Number:	(215)568-3439
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	215-568-3100
Email:	assignments@bakerlaw.com
Correspondent Name:	BAKER & HOSTETLER LLP
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Address Line 2:	CIRA CENTRE, 12TH FLOOR
Address Line 4:	PHILADELPHIA, PENNSYLVANIA 19104-2891
ATTORNEY DOCKET NUMBER:	101716.000125
NAME OF SUBMITTER:	CARLY WHIMS

SIGNATURE:	/Carly Whims/
DATE SIGNED:	01/15/2016
Total Attachments: 10 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif source=Assignment#page4.tif source=Assignment#page5.tif source=Assignment#page6.tif source=Assignment#page7.tif source=Assignment#page8.tif source=Assignment#page9.tif source=Assignment#page10.tif	

ASSIGNMENT

WHEREAS, I, Hisanori MATSUO, a citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number (the invention), which is entitled "METHOD AND APPARATUS FOR MEASURING SURFACE PROPERTIES OF POLISHING PAD" (the subject application), and which claims priority to Japanese patent application number 2014-265694 filed December 26, 2014 (the priority application). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, and Kyushu Institute of Technology, ASSIGNEE, having a place of business at 1-1 Sensui-cho, Tobata-ku, Kitakyushu-shi, Fukuoka, Japan, are desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming

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the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 8th day of January, year of 2016.

Hisanori Matsuo

Signature (Hisanori MATSUO)

STATEMENT OF WITNESS

SIGNED at _____

(City)

(Country)

This _____ day of _____, 201__.

I, _____ whose full

residence address is _____

_____ was personally present and did see _____ execute the above assignment on the _____ day of _____, 201__, and such assignor is personally known to me to be the person described in such document.

Signature of Witness

The foregoing assignment covers patent application number _____, filed on

_____.

Name of Attorney:

Registration No.:

Date of Insertion:

ASSIGNMENT

WHEREAS, I, Yoshihiro MOCHIZUKI, a citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled "METHOD AND APPARATUS FOR MEASURING SURFACE PROPERTIES OF POLISHING PAD" ("the subject application"), and which claims priority to Japanese patent application number 2014-265694 filed December 26, 2014 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, and Kyushu Institute of Technology, ASSIGNEE, having a place of business at 1-1 Sensui-cho, Tobata-ku, Kitakyushu-shi, Fukuoka, Japan, are desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

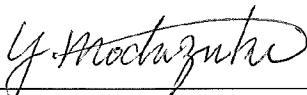
AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming

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the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 8th day of January, year of 2016.


Signature (Yoshihiro MOCHIZUKI)

STATEMENT OF WITNESS

SIGNED at _____

(City) (Country)

This ____ day of _____, 201__.

I, _____ whose full

residence address is _____

_____ was personally present and did see _____ execute the above assignment on the _____ day of _____, 201__, and such assignor is personally known to me to be the person described in such document.

Signature of Witness

The foregoing assignment covers patent application number _____, filed on

_____.

Name of Attorney:

Registration No.:

Date of Insertion:

ASSIGNMENT

WHEREAS, I, Keisuke SUZUKI, a citizen of Japan, residing at c/o Kyushu Institute of Technology, 680-4 Kawazu, Iizuka-shi, Fukuoka, 820-8502, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number (the invention), which is entitled "METHOD AND APPARATUS FOR MEASURING SURFACE PROPERTIES OF POLISHING PAD" (the subject application), and which claims priority to Japanese patent application number 2014-265694 filed December 26, 2014 (the priority application). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, and Kyushu Institute of Technology, ASSIGNEE, having a place of business at 1-1 Sensui-cho, Tobata-ku, Kitakyushu-shi, Fukuoka, Japan, are desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming

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the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 8th day of January, year of 2016.

Keisuke Suzuki
Signature (Keisuke SUZUKI)

STATEMENT OF WITNESS

SIGNED at _____

(City) (Country)

This _____ day of _____, 201__.

I, _____ whose full
residence address is _____

_____ was personally present and did see _____ execute the above assignment on the
_____ day of _____, 201__, and such assignor is personally known to me to be the
person described in such document.

Signature of Witness

The foregoing assignment covers patent application number _____, filed on
_____.

Name of Attorney:
Registration No.:
Date of Insertion:

ASSIGNMENT

WHEREAS, I, Takahiro TAJIRI, a citizen of Japan, residing at c/o Kyushu Institute of Technology, 680-4 Kawazu, Iizuka-shi, Fukuoka, 820-8502, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled "METHOD AND APPARATUS FOR MEASURING SURFACE PROPERTIES OF POLISHING PAD" ("the subject application"), and which claims priority to Japanese patent application number 2014-265694 filed December 26, 2014 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, and Kyushu Institute of Technology, ASSIGNEE, having a place of business at 1-1 Sensui-cho, Tobata-ku, Kitakyushu-shi, Fukuoka, Japan, are desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

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the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 8th day of January, year of 2016.

Takahiro TAJIRI

Signature (Takahiro TAJIRI)

STATEMENT OF WITNESS

SIGNED at _____

(City)

(Country)

This _____ day of _____, 201__.

I, _____ whose full

residence address is _____

_____ was personally present and did see _____ execute the above assignment on the _____ day of _____, 201__, and such assignor is personally known to me to be the person described in such document.

Signature of Witness

The foregoing assignment covers patent application number _____, filed on _____.

Name of Attorney:

Registration No.:

Date of Insertion:

ASSIGNMENT

WHEREAS, I, Panart Khajornrungruang, a citizen of Thailand, residing at c/o Kyushu Institute of Technology, 680-4 Kawazu, Iizuka-shi, Fukuoka, 820-8502, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number (the invention), which is entitled "METHOD AND APPARATUS FOR MEASURING SURFACE PROPERTIES OF POLISHING PAD" (the subject application), and which claims priority to Japanese patent application number 2014-265694 filed December 26, 2014 (the priority application). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

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the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 8th day of January, year of 2016.



Signature (Panart Khajornrungruang)

STATEMENT OF WITNESS

SIGNED at _____

(City) (Country)

This ____ day of _____, 201__.

I, _____ whose full
residence address is _____

_____ was personally present and did see _____ execute the above assignment on the
____ day of _____, 201__, and such assignor is personally known to me to be the
person described in such document.

Signature of Witness

The foregoing assignment covers patent application number _____, filed on
_____.

Name of Attorney:

Registration No.:

Date of Insertion: